

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT7747423

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HANIA A YASSIN	12/27/2022
SHANTHI RAVINDRAN	01/05/2023
DANIEL HAMMOND	12/21/2022
RECEIVING PARTY DATA	
Name:	MOTOROLA SOLUTIONS INC.
Street Address:	500 W. MONROE STREET
Internal Address:	43RD FLOOR
City:	CHICAGO
State/Country:	ILLINOIS
Postal Code:	60661
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	18067801
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Email:	usadocketing@motorolasolutions.com
Correspondent Name:	MOTOROLA SOLUTIONS, INC.
Address Line 1:	500 W. MONROE ST.
Address Line 2:	43RD FLOOR
Address Line 4:	CHICAGO, ILLINOIS 60661
ATTORNEY DOCKET NUMBER:	PAT28860-US-PRI
NAME OF SUBMITTER:	NANETTE B. ORR
SIGNATURE:	/Nanette B. Orr/
DATE SIGNED:	01/18/2023
Total Attachments: 4	
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ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, **HANIA A YASSIN, CHICAGO, ILLINOIS; SHANTHI RAVINDRAN, SINGAPORE AND DANIEL HAMMOND, MAPLE RIDGE, CANADA,** have sold, assigned and transferred, and do hereby sell, assign and transfer, unto MOTOROLA SOLUTIONS, INC., a corporation of the State of Delaware, having its principal office in Chicago, State of Illinois, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in **METHOD AND SYSTEM FOR CREATION AND APPLICATION OF PARKED VEHICLE SECURITY RULES**, Application Serial No.: 18/067,801 filed: December 19, 2022 (Docket No. PAT28860-US-PRI) described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any nonprovisional, division, extension, continuation, reexamination or reissue thereof.

We hereby also sell, assign and transfer unto MOTOROLA SOLUTIONS, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefore in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize MOTOROLA SOLUTIONS, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, reexamination or reissue to MOTOROLA SOLUTIONS, INC., for the sole use and benefit of MOTOROLA SOLUTIONS, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent

authorities in foreign countries to issue the patents of their respective countries to MOTOROLA SOLUTIONS, INC.

We agree that, when requested, we will, without charge to MOTOROLA SOLUTIONS, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in MOTOROLA SOLUTIONS, INC., its successors, assigns and legal representatives or nominees.

We hereby consent to the inclusion of our respective Inventor city names and Inventor country names to be listed in the patent application filing formalities in the United States and/or foreign countries and for inclusion upon the printed face of any of the aforesaid application, division, extension, continuation, reexamination or reissue published applications and/or issued patents. I also understand that I can make a formal request to exclude Inventor City and Inventor country, which must be sent to patenttoolhelp@motorolasolutions prior to filing the aforementioned patent application.

We covenant with MOTOROLA SOLUTIONS, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

(1) Legal Name of Inventor: **HANIA A YASSIN**

Signature: *Hania A. Yassin* Date: 12/27/22

(2) Legal Name of Inventor: **SHANTHI RAVINDRAN**

Signature: _____ Date: _____

(3) Legal Name of Inventor: **DANIEL HAMMOND**

Signature: _____ Date: _____

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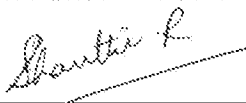
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(1) Legal Name of Inventor: **HANIA A YASSIN**

Signature: _____ Date: _____

(2) Legal Name of Inventor: **SHANTHI RAVINDRAN**

Signature:  Date: 5 Jan 2023

(3) Legal Name of Inventor: **DANIEL HAMMOND**

Signature: _____ Date: _____

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(1) Legal Name of Inventor: **HANIA A YASSIN**

Signature: _____ Date: _____

(2) Legal Name of Inventor: **SHANTHI RAVINDRAN**

Signature: _____ Date: _____

(3) Legal Name of Inventor: **DANIEL HAMMOND**

Signature: /Daniel Hammond/ Date: Dec. 21/22